

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: John Erickson et al.

Serial No.: 10/747,639

Group Art Unit: 1791

Filed: December 29, 2003

Examiner: Lee, Edmund H.

For: A Method of Making a Molded Article

**RESPONSE AFTER FINAL**

**Mail Stop AF**  
**Commissioner for Patents**  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the final Office Action from the Examiner dated May 1, 2008, please consider the accompanying remarks. A complete listing of all claims pending in the application is included for the Examiner's convenience. This Response is timely filed thus it is believed that no fees are presently due. Further, this Response is filed within the 2-month period for response after final rejection.